FAIRCHILD

SEMICONDUCTOR

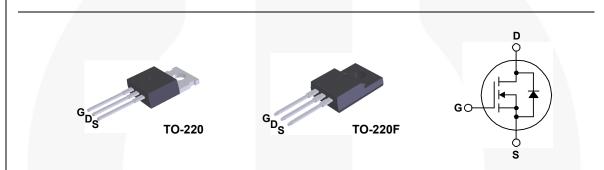
FQP5N60C / FQPF5N60C **N-Channel QFET® MOSFET** 600 V, 4.5 A, 2.5 Ω

Description

This N-Channel enhancement mode power MOSFET is • 4.5 A, 600 V, R_{DS(on)} = 2.5 Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 15 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 6.5 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- I_D = 2.25 A



Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

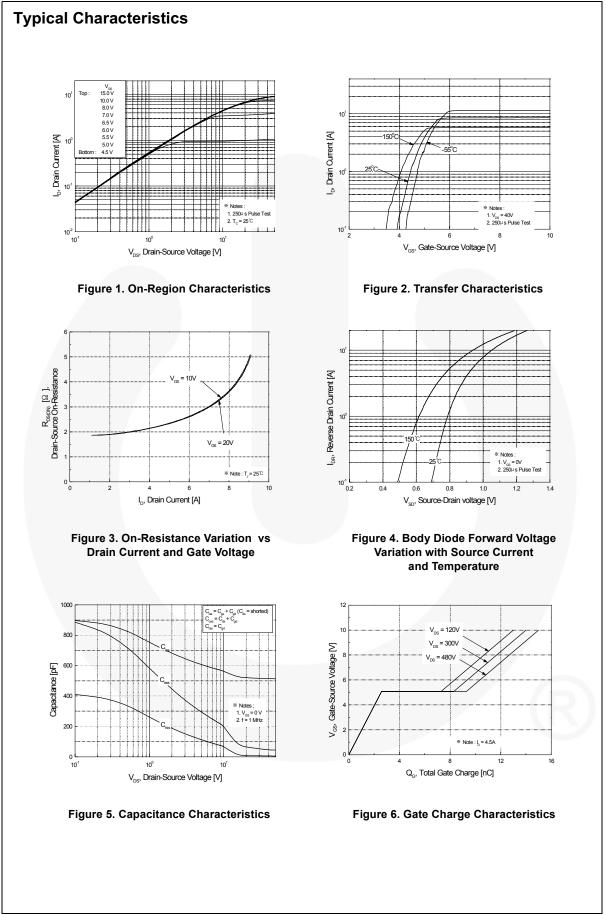
Symbol	Parameter	FQP5N60C	Unit V		
V _{DSS}	Drain-Source Voltage	6			
I _D	Drain Current - Continuous (T _C = 25°C)		4.5	4.5 *	А
	- Continuous (T _C = 100°C)	_	2.6	2.6 *	А
I _{DM}	Drain Current - Pulsed (N	ote 1)	18	18 *	А
V _{GSS}	Gate-Source Voltage	±	V		
E _{AS}	Single Pulsed Avalanche Energy (N	ote 2)	210		mJ
I _{AR}	Avalanche Current (N	ote 1)	4.5		Α
E _{AR}	Repetitive Avalanche Energy (N	ote 1)	10		mJ
dv/dt	Peak Diode Recovery dv/dt		4.5		V/ns
P _D	Power Dissipation (T _C = 25°C)		100	33	W
	- Derate above 25°C	0.8	0.26	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		3	°C	

Thermal Characteristics

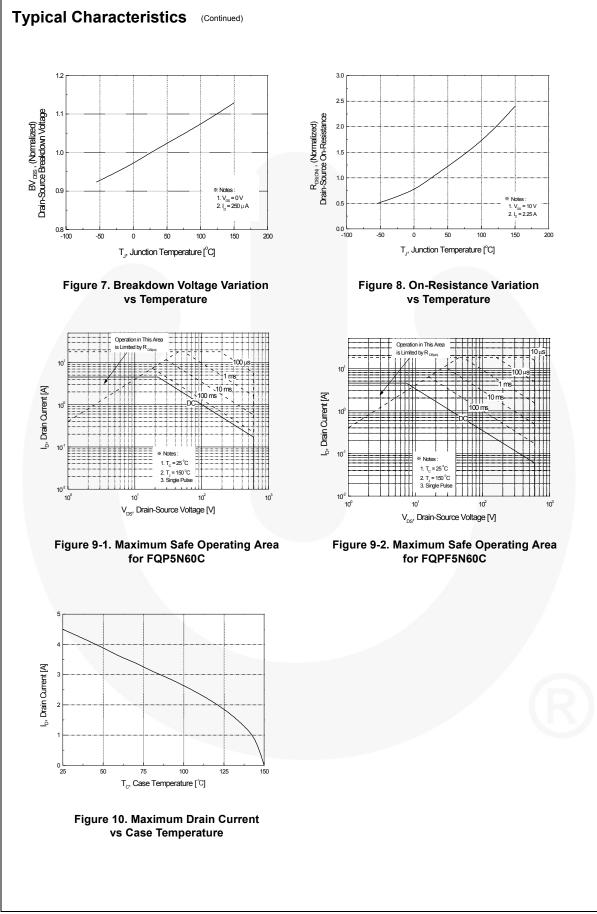
Symbol	Parameter	FQP9N90C	FQPF9N90CT	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.25	3.79	°C/W	
R _{0CS}	Thermal Resistance, Case-to-Sink Typ, Max.	0.5		°C/W	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W	

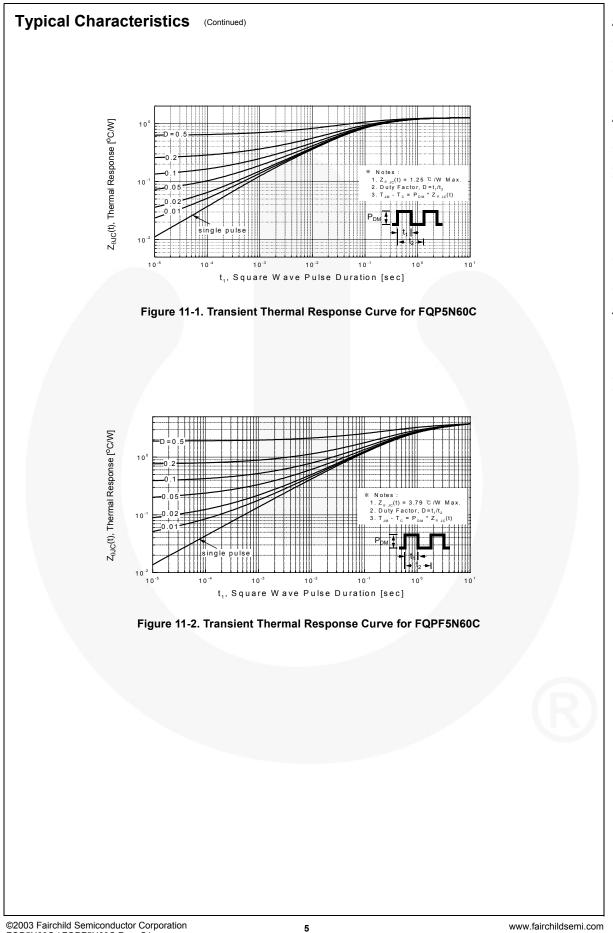
December 2013

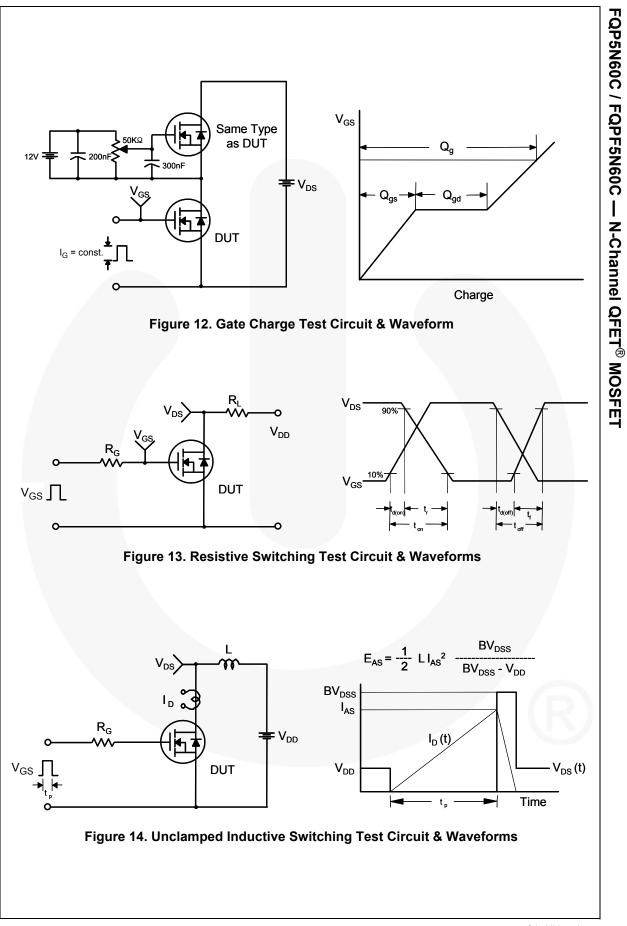
FQP5N60C FQP5N60C TO		Top Mark	Pack	kage Packing Method Re		Reel S	Size	Tape Width		Quantity		
		FQP5N60C		220	Tube		N/A		N/A		50 units	
		220F Tube N/				Ą	N/A		50 units			
lectric	cal Cha	racteristics	T _C = 25°C	cunless oth	nerwise noted.							
Symbol		Parameter			Test Con	ditions		Min.	Тур.	Max.	Unit	
Off Cha	aracterist	ics										
BV _{DSS}		rce Breakdown Volta	ade	$V_{CS} =$	0 V, I _D = 25	50 uA		600			V	
ΔBV _{DSS}	Breakdown Voltage Temperature											
/ $\Delta T_{\rm J}$		Coefficient		$I_D = 250 \ \mu\text{A}$, Referenced to 25°C				0.6		V/°C		
I _{DSS}	Zero Gate Voltage Drain Current			V _{DS} = 600 V, V _{GS} = 0 V					1	μA		
				$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$						10	μA	
GSSF		y Leakage Current, I		$V_{GS} = 30 V, V_{DS} = 0 V$ $V_{GS} = -30 V, V_{DS} = 0 V$				100	nA			
GSSR	Gate-Bod	y Leakage Current, F	Reverse	v _{GS} =	-30 V, V _{DS}	= 0 V				-100	nA	
On Cha	racterist	ics										
V _{GS(th)}		shold Voltage		V _{DS} =	V _{GS} , I _D = 2	50 µA		2.0		4.0	V	
R _{DS(on)}	Static Dra On-Resist			-	10 V, I _D = 2				2.0	2.5	Ω	
9 _{FS}	Forward T	ransconductance	_	V _{DS} =	40 V, I _D = 2	2.25 A			4.7		S	
									I			
-	1	cteristics	_	1								
C _{iss}	Input Cap		_	_	25 V, V _{GS} =	= 0 V,			515	670	pF	
C _{oss}		pacitance	_	f = 1.0	MHz				55	72	pF	
C _{rss}	Reverse	ransfer Capacitance	;						6.5	8.5	pF	
Switchi	ing Chara	acteristics										
t _{d(on)}		Delay Time	_	Vpp =	300 V, I _D =	4.5			10	30	ns	
t _r	Turn-On F	Rise Time			= 25 Ω	ч.0			42	90	ns	
t _{d(off)}	Turn-Off E	elay Time		,,G					38	85	ns	
t _f	Turn-Off F	all Time					(Note 4)		46	100	ns	
Qg	Total Gate	Charge		V _{DS} =	480 V, I _D =	4.5 A,			15	19	nC	
Q _{gs}	Gate-Sou	rce Charge		V _{GS} =					2.5		nC	
Q _{gd}	Gate-Drai	n Charge					(Note 4)	-	6.6		nC	
Ť.									I		/	
Drain-S	ource Di	ode Characteri	stics ar	nd Max	cimum R	atings						
I _S	Maximum	Continuous Drain-S	ource Dic	de Forw	ard Curren	t				4.5	Α	
I _{SM}	Maximum	Pulsed Drain-Sourc	e Diode F	orward	Current					18	Α	
V _{SD}	Drain-Sou	rce Diode Forward \	/oltage	V _{GS} =	0 V, I _S = 4.	5 A				1.4	V	
t _{rr}	Reverse F	Recovery Time			0 V, I _S = 4.				300		ns	
Q _{rr}	Reverse F	Recovery Charge		dl _F / dt	: = 100 A/μs	6		-	2.2		μC	

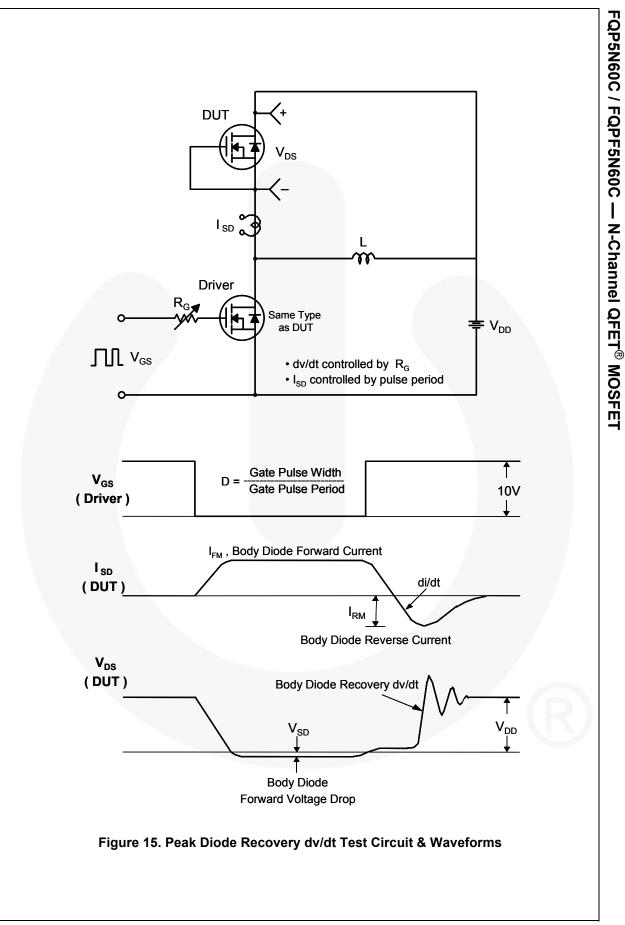


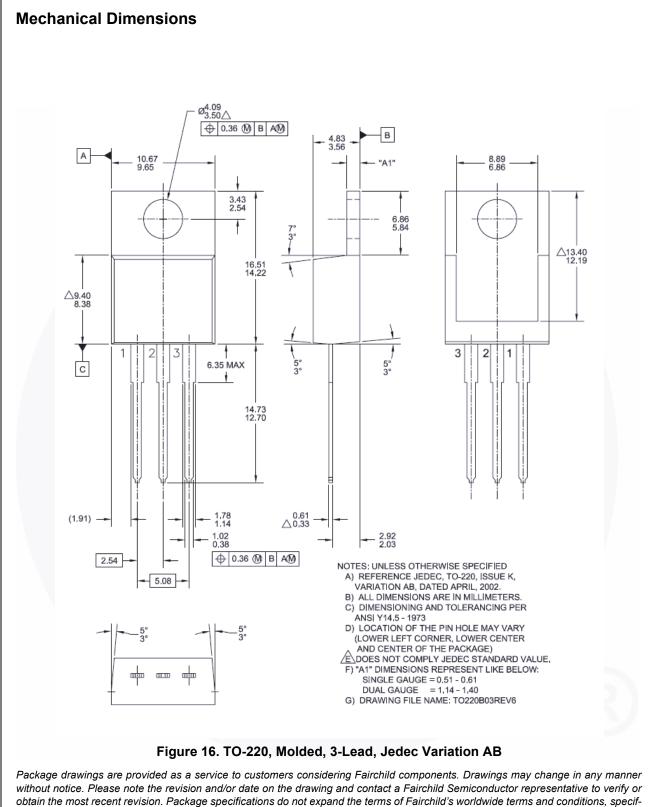
FQP5N60C / FQPF5N60C — N-Channel QFET[®] MOSFET











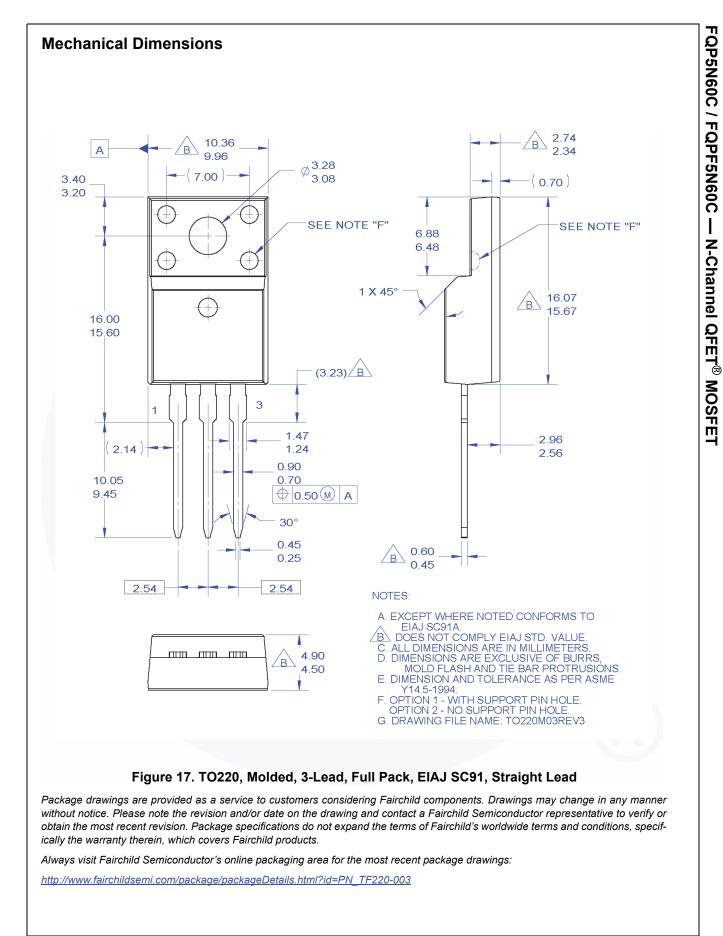
N-Channel QFET[®] MOSFET

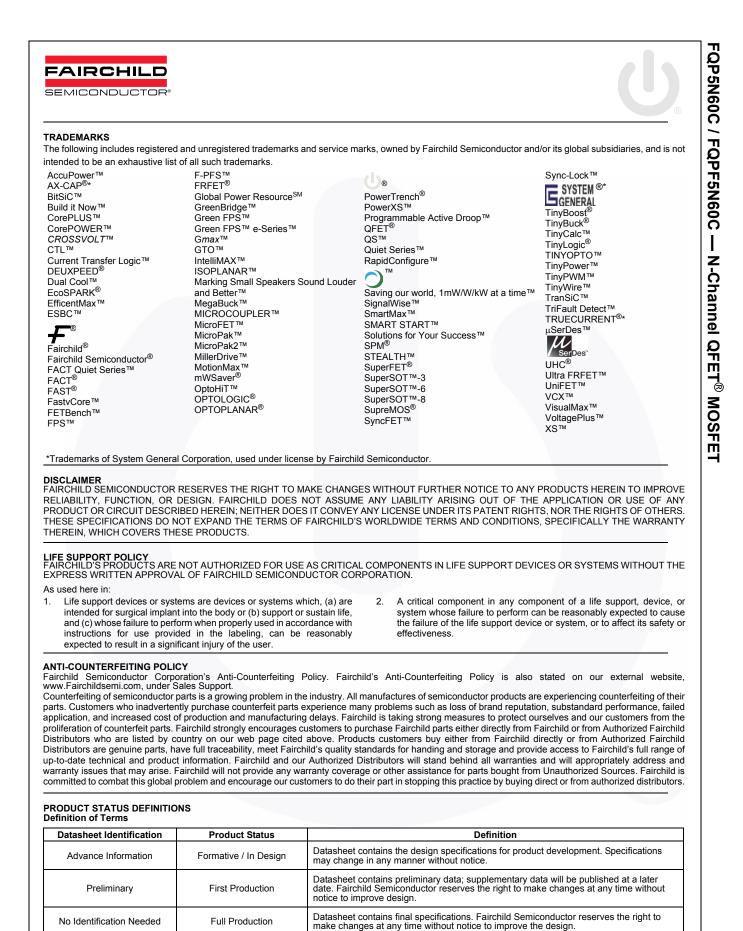
FQP5N60C / FQPF5N60C ---

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT220-003

ically the warranty therein, which covers Fairchild products.





Not In Production

Obsolete

Datasheet contains specifications on a product that is discontinued by Fairchild

Semiconductor. The datasheet is for reference information only.

Rev. 166